TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74LCX05F,TC74LCX05FN,TC74LCX05FT

Low-Voltage HEX Inverter with 5-V Tolerant Inputs and Outputs (open-drain)

The TC74LCX05F/FN/FT is a high-performance CMOS inverter

Designed for use in 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

Pin configuration and function are the same as the TC74LCX04, but the TC74LCX05F/FN/FT has high performance MOS N-channel transistor. (open-drain outputs)

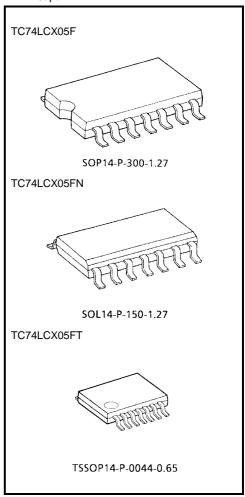
The device is designed for low-voltage (3.3 V) VCC applications, but it could be used to interface to 5-V supply environment for inputs.

All inputs are equipped with protection circuits against static discharge.

Features

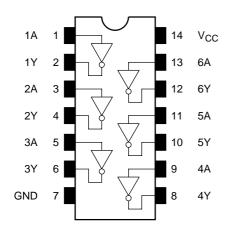
- Low-voltage operation: VCC = 2.0 to 3.6 V
- High-speed operation: $t_{pz} = 5.0 \text{ ns (max) (VCC} = 3.0 \text{ to } 3.6 \text{ V)}$
- Output current: IOL = 24 mA (min) (VCC = 3.0 V)
- Latch-up performance: -500 mA
- Available in JEDEC SOP, JEITA SOP and TSSOP
- Open-drain outputs
- Power-down protection is provided on all inputs and outputs
- Pin and function compatible with the 74 series (74AC/VHC/HC/F/ALS/LS etc.) 05 type

Note: xxxFN (JEDEC SOP) is not available in Japan.



Weight SOP14-P-300-1.27: 0.18 g (typ.) SOL14-P-150-1.27: 0.12 g (typ.) TSSOP14-P-0044-0.65: 0.06 g (typ.)

Pin Assignment (top view)



IEC Logic Symbol

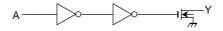
	1		^	\neg	2	4) (
1A -	3	1	<u> </u>		4	1Y
2A -	5			_	6	2Y
3A -	<u> </u>	-		<u> </u>	0	- 3Y
	9				8	4Y
4A -	11			— [10	
5A -	40	1				5Y
6A -	13				12	6Y

Truth Table

Inputs	Outputs
Α	Υ
L	Z
Н	L

Z: High impedance

System Diagram (per gate)



Maximum Ratings

Characteristics	Symbol	Rating	Unit
Power supply voltage	V _{CC}	-0.5 to 7.0	V
DC input voltage	V _{IN}	-0.5 to 7.0	V
		-0.5 to 7.0 (Note 1)	
DC output voltage	V _{OUT}	-0.5 to $V_{CC}+0.5$	V
		(Note 2)	
Input diode current	I _{IK}	-50	mA
Output diode current	lok	-50 (Note 3)	mA
DC output current	lout	50	mA
Power dissipation	PD	180	mW
DC V _{CC} /ground current	I _{CC} /I _{GND}	±100	mA
Storage temperature	T _{stg}	-65 to 150	°C

Note 1: Output in OFF state

Note 2: Low state. IOUT absolute maximum rating must be observed.

Note 3: V_{OUT} < GND

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Recommended Operating Conditions

Characteristics	cteristics Symbol Rating		Unit	
Device complex selface	V	2.0 to 3.6	V	
Power supply voltage	Vcc	1.5 to 3.6 (Note 4)		
Input voltage	V _{IN}	0 to 5.5	V	
Output voltage	V _{OUT}	0 to 5.5 (Note 5)	V	
Output voltage	VOU1	0 to V _{CC} (Note 6)	V	
Output current	I _{OH} /I _{OI}	24 (Note 7)	mA	
Output current	IOH/IOL	12 (Note 8)	ША	
Operating temperature	T _{opr}	-40 to 85	°C	
Input rise and fall time	dt/dv	0 to 10 (Note 9)	ns/V	

Note 4: Data retention only

Note 5: Output in OFF state

Note 6: Low state

Note 7: $V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$

Note 8: $V_{CC} = 2.7 \text{ to } 3.0 \text{ V}$

Note 9: $V_{IN} = 0.8 \text{ to } 2.0 \text{ V}, V_{CC} = 3.0 \text{ V}$

Electrical Characteristics

DC Characteristics ($Ta = -40 \text{ to } 85^{\circ}\text{C}$)

Characteristics		Symbol	Test Condition		V _{CC} (V)	Min	Max	Unit
	H-level	V _{IH}	_		2.7 to 3.6	2.0	_	\/
Input voltage	L-level	V _{IL}		_	2.7 to 3.6	_	0.8	V
				$I_{OL} = 100 \mu A$	2.7 to 3.6		0.2	V
Output valtage	L-level	\/ - ·	Maria Mari	I _{OL} = 12 mA	2.7	_	0.4	
Output voltage	L-ievei	V _{OL}	V _{IN} = V _{IH}	I _{OL} = 16 mA	3.0	_	0.4	
				I _{OL} = 24 mA	3.0	_	0.55	
Input leakage current		I _{IN}	V _{IN} = 0 to 5.5 V		2.7 to 3.6	_	±5.0	μΑ
Output OFF state	current	loz	$V_{IN} = V_{IL}$, $V_{OUT} = 0$ to 5.5 V		2.7 to 3.6	_	±5.0	μΑ
Power-off leakage current		l _{OFF}	V _{IN} /V _{OUT} = 5.5 V		0	_	10.0	μΑ
Quiescent supply current		Las	V _{IN} = V _{CC} or GND		2.7 to 3.6	_	10.0	
		Icc	$V_{IN}/V_{OUT} = 3.6 \text{ to}$	o 5.5 V	2.7 to 3.6	_	±10.0	μΑ
Increase in Icc per input		Δlcc	$V_{IH} = V_{CC} - 0.6$	V	2.7 to 3.6		500	

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AC Characteristics ($Ta = -40 \text{ to } 85^{\circ}\text{C}$)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Min	Max	Unit
Output enable time		Figure 1, Figure 2	2.7	1.0	6.0	- ns
Output enable time	t _{pZL}	rigure 1, rigure 2	3.3 ± 0.3	0.8	5.0	
Output disable time	+	Figure 1, Figure 2	2.7	1.0	6.0	ns
Output disable time	t _{pLZ}		3.3 ± 0.3	0.8	5.0	119
Output to output skew	t	(Note 10)	2.7	_	_	nc
Output to output skew	tosZL		3.3 ± 0.3	_	1.0	ns

Note 10: Parameter guaranteed by design.

 $(t_{OSZL} = |t_{pZLm} - t_{pZLn}|)$

Dynamic Switching Characteristics

(Ta = 25°C, input: $t_r = t_f = 2.5 \text{ ns}$, $C_L = 50 \text{ pF}$, $R_L = 500 \Omega$)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Unit
Quiet output maximum dynamic V _{OL}	V _{OLP}	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	8.0	V
Quiet output minimum dynamic V _{OL}	V _{OLV}	V _{IH} = 3.3 V, V _{IL} = 0 V	3.3	0.8	V

Capacitive Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition		V _{CC} (V)	Тур.	Unit
Input capacitance	C _{IN}			3.3	7	рF
Output capacitance	C _{OUT}			3.3	8	рF
Power dissipation capacitance	C _{PD}	f _{IN} = 10 MHz	(Note 11)	3.3	5	pF

Note 11: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 I_{CC} (opr) = $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/6$ (per gate)

AC Test Circuit

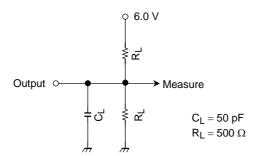


Figure 1

AC Waveform

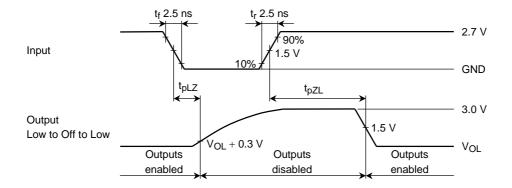
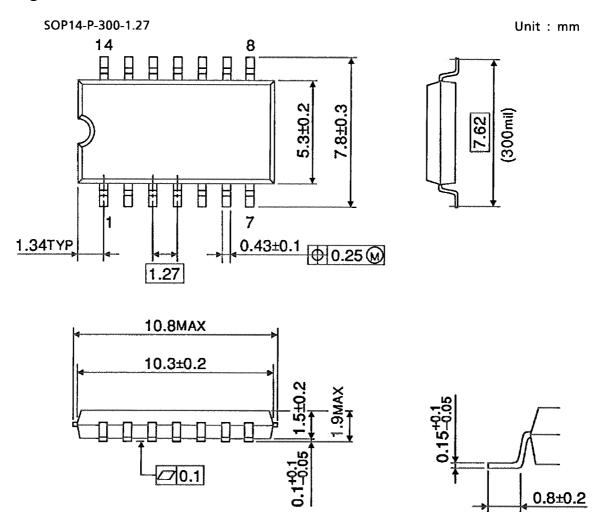


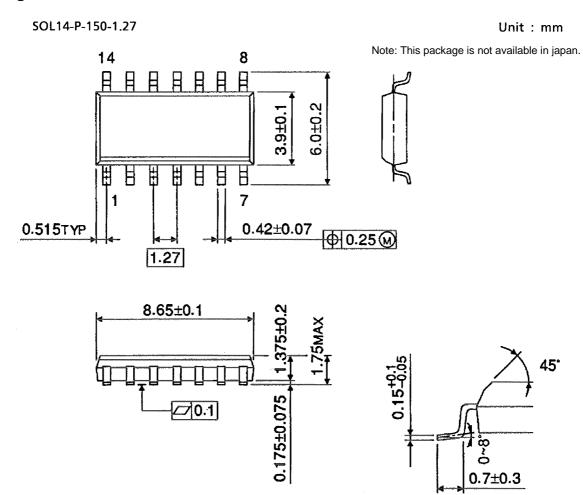
Figure 2 t_{pLZ}, t_{pZL}

Package Dimensions



Weight: 0.18 g (typ.)

Package Dimensions

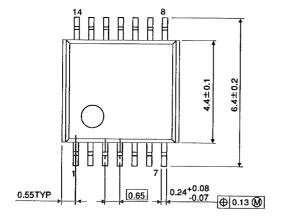


Weight: 0.12 g (typ.)

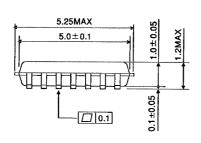
Unit: mm

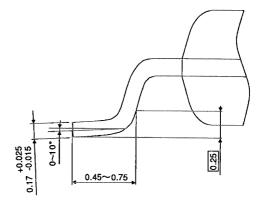
Package Dimensions

TSSOP14-P-0044-0.65









Weight: 0.06 g (typ.)

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